

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent 255/236 P00-0021 B

In re Application of:) Group Art Unit: 1746
BERGMAN, Eric J.) Examiner: F. Stinson
Serial No.: 09/621,028	RECEIVED
Filed: July 21, 2000	Nov 2 9 2001
For: PROCESS AND APPARATUS FOR TREATING A WORKPIECE SUCH AS A SEMICONDUCTOR WAFER	TC 1700

SUPPLEMENTAL STATEMENT OF RELATED APPLICATIONS

Commissioner for Patents Washington, D.C. 20231

Sir:

Further to Applicant's Preliminary Amendment mailed February 9, 2001, Applicant advises:

1) Serial No. 08/853,649 issued on June 5, 2001 as U.S. Patent No. 6,240,933. Continuations of 08/853,649 now pending are 09/811,925; 09/836,080 and 09/836,059.

CERTIFICATE OF MAILING (37 C.F.R. §1.8a)

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

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Signature of Person Mailing Paper

2) Serial No. 09/061,318 is abandoned. Continuation/Divisional Applications of 09/061,318 are:

Serial No.	Filing Date	Patent No.
09/536,251	3/17/00	pending
09/677,934	10/2/00	6,267,125
09/677,929	10/2/00	6,273,108
09/677, 925	10/2/00	pending
09/837,722	4/18/01	pending.

Copies of the patents listed above are attached to the accompanying Information Disclosure Statement. Copies of the pending claims from the applications listed above are enclosed.

Respectfully submitted,

LYON & LYON LLP

Dated: November <u>13</u>, 2001

Bv:

Kenneth H. Ohriner Reg. No. 31,646

633 West Fifth Street Suite 4700 Los Angeles, California 90071-2066 (213) 489-1600 - Fax (213) 955-0440

Enclosures



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:) Group Art Unit: 1746
BERGMAN, Eric J.	Examiner: F. Stinson Nov 29
Serial No.: 09/621,028	
Filed: July 21, 2000	· 0 0
For: Process And Apparatus For Treating A Workpiece Such As A Semiconductor Wafer	

THIRD SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In compliance with the Applicants' duty under 37 CFR 1.97-98, the following information is brought to the attention of the Examiner. The items are listed on the attached form PTO-1449 and copies are enclosed for the convenience of the Examiner.

The item identified in this Supplemental Information Disclosure Statement may or may not be "material" pursuant to 37 CFR 1.56 and the submission thereof by Applicants shall not be construed as an admission that any such patent, publication or other information referred to therein is

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Laura Murphy

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Patent 255/236 P00-0021

material or considered to be material (37 CFR 1.97(h)), or even qualifies as "prior art" under 35 U.S.C. § 102 with respect to this invention unless specifically designated by Applicants as such.

The filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information, as defined in 37 CFR 1.56, exists.

Applicant believes that no fee should be required for consideration of this Information

Disclosure Statement. Should Applicant be in error, however, please charge any fee required for the consideration of this paper to Deposit Account No. 12-2475.

Respectfully submitted,

LYON & LYON LLP

sy: /\cm

Reg. No. 31,646

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